

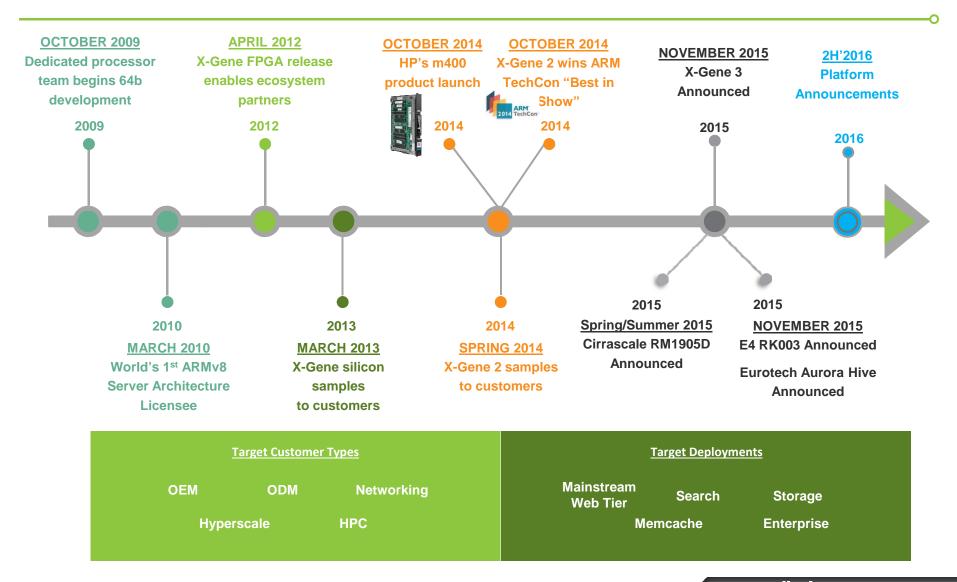
X-Gene® in High Performance Computing Rob Reiner

Director of Marketing

rreiner@apm.com

ARM HPC User Group Session @ SC16 November 14, 2016

X-Gene Driving ARM in Data Centers



ARM Platforms Powered by X-Gene





















Data Center



HP ProLiant m400











Gigabyte R120-P30 & MP30



ODM Platofrms

Storage



HPE StoreVirtual3200 Enterprise Storage Platform







Mudan Storage Platform

Networking



Tier1 Datacenter Switch



Kontron SYMKLOUD T4010



Programmable PCIE Accelerator Card

High-Performance Computing



E4 ARKA RK003



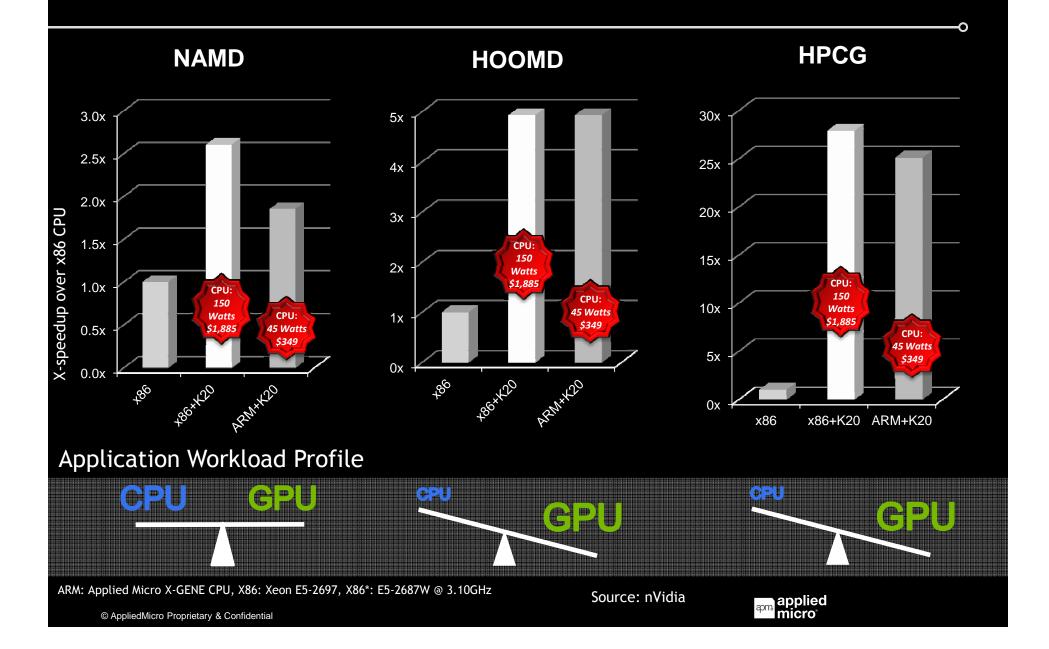




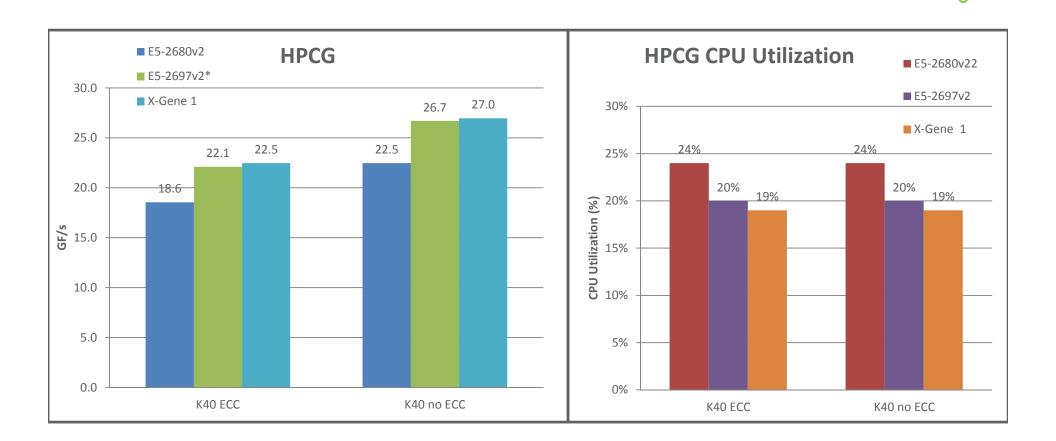


Eurotech Aurora "Hive"

X-Gene + GPU: Solid Platform for GPU-Optimized Apps



X-GENE & X86 NVIDIA K40 BENCHMARK: HPCG

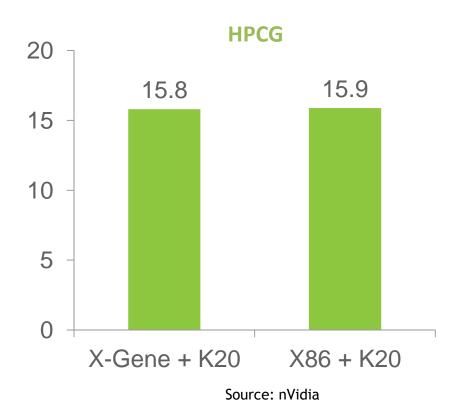


Source: APM, Nvidia

X-Gene: Applied Micro Gigabyte MP30 Platform 8-core @ 2.4GHz, 32GB DDR3-1600, Ubuntu 15.04
X86: Xeon E5-2680v2 10C/20T @2.8GHz Turbo/HT Enabled, 64GB DDR3-1600, CentOS 6.6, Xeon E5-2697v2 12C/24T @2.7GHz CUDA 6.5



X-Gene + GPU : Solid Platform for GPU-Optimized Apps



Cirrascale RM1905D







X-Gene: AppliedMicro X-Gene 1 ARM CPU

x86: Xeon™ E5-2697v2 CPU

K20: nVidia Tesla K20 GPU



E4 Arka HPC Platform based on X-Gene

E4 ARKA series the first ARMv8 plafroms dedicated to HPC



E4 RK003

FEATURES

Form Factor 2U

CPU 1x APM X-Gene 8 cores

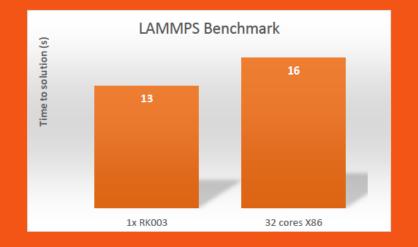
GPU up to 2x NVIDIA Kepler® K20, K40, K80

Memory Up to 128 GB RAM DDR3

Network 2x 10 GbE SFP+, 1x Infiniband FDR QSFP

Storage 4x SATA 3.0

Expansion slots 2x PCI-E 3.0 x8 (in x16)









Source: E4



X-Gene HPC Platforms

Eurotech Aurora Hive

- Most dense architecture in the market
 - 1.5 PFlop/s DP peak per rack
 - 5 Pflop/s SP peak per rack
- Highest energy efficiency.
 - At system level > 6 GFlops / Watt sustained
 - At datacenter level with PUE of 1.05
- **Distinctive flexibility**. Direct hot water cooled with no constraints for the choice of components:
 - Intel or ARM CPU
 - NVIDIA or AMD accelerators
 - Intel coprocessors
 - Any other PCle card
- Direct hot water cooling of all components
- First and only system with multiple direct hot water cooled GPGPUs











X-Gene® 3

- Third Generation ARMv8 Processor
- Quantum Jump in ARM Server Landscape
- 6x the performance versus current X-Gene family
- 8 64-bit DDR4 Memory Controllers with ECC
- 1TB Memory per Socket
- 30% Lower Power per Core
- Addresses mainstream work-loads used by Tier 1 hyperscale datacenter customers
- Targets data analytics, HPC, machine learning, web/caching servers, web search

Sampling Q1 2017



X-Gene® 3 Overview

Processor Subsystem

- 32 ARM™ v8 64-bit CPU cores at up to 3 GHz
- 32 KB I-cache/D-cache
- Shared 256 KB L2 cache per 2 cores

Memory

- 32 MB globally shared L3 cache
- Eight DDR4-2667 channels with ECC and RAS
- Up to 16 DIMMs and 1TB/socket

System Resources

- GICv3 Interrupt Controller
- Full IO Virtualization
- Enterprise server-class RAS

Connectivity

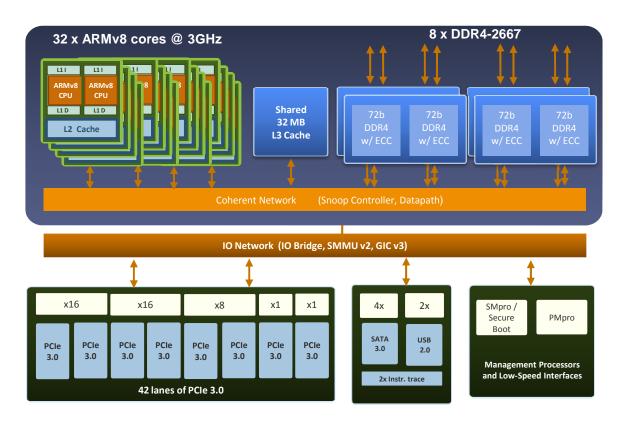
- 42 lanes of PCIe Gen 3 with 8 controllers
- 4 x SATA Gen 3 ports
- 2 x USB 2.0 ports
- 1 x RGMII port

Functionality

- ARM SBSA Level 3
 - EL3, secure memory and secure boot support
- Advanced Power Management with ACPI/PSCI
- Full SBBR compliance with UEFI

Performance

• SPECint_rate ~550; TDP: 125W



Conclusion

- X-Gene 1/X-Gene 2 are in production today
 - Wide Range of HPC Platforms and Deployments
- Higher Performance/\$ and Performance/Watt reduces the overall TCO
- X-Gene 1 and X-Gene 2 pave the way for Third Generation X-Gene 3
- X-Gene 3 Delivers Quantum Jump in ARM Server Landscape



Thank You!